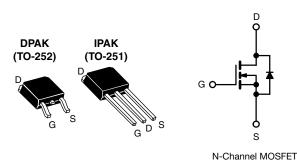
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Power MOSFET



| PRODUCT SUMMARY | | | | | |
|--------------------------|----------------------------|-----|--|--|--|
| V _{DS} (V) | 400 | | | | |
| R _{DS(on)} (Ω) | V _{GS} = 10 V 3.6 | | | | |
| Q _g max. (nC) | 12 | | | | |
| Q _{gs} (nC) | 1.9 | | | | |
| Q _{gd} (nC) | 6.5 | | | | |
| Configuration | Sin | gle | | | |

FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- Surface-mount (IRFR310, SiHFR310)
- Straight lead (IRFU310, SiHFU310)
- Available in tape and reel
- Fast switching
- Fully avalanche rated
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



DESCRIPTION

Third generation power MOSFETs form Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface-mount applications.

| ORDERING INFORMATION | | | | | |
|---------------------------------|-----------------|------------------|-------------------|---------------|--|
| Package | DPAK (TO-252) | DPAK (TO-252) | DPAK (TO-252) | IPAK (TO-251) | |
| Lead (Pb)-free and halogen-free | SiHFR310-GE3 | SiHFR310TRL-GE3 | SiHFR310TR-GE3 | SiHFU310-GE3 | |
| Lead (FD)-11ee and halogen-free | SiHFR310TRR-GE3 | IRFR310TRPbF-BE3 | IRFR310TRLPbF-BE3 | - | |
| Lead (Pb)-free | IRFR310PbF | IRFR310TRLPbF a | IRFR310TRPbF a | IRFU310PbF | |

Note

a. See device orientation

| ABSOLUTE MAXIMUM RATINGS ($T_{\mbox{\scriptsize C}}$ | = 25 °C, unless otherw | ise noted) | | |
|---|--|-----------------------------------|--|-------|
| PARAMETER | | SYMBOL | LIMIT | UNIT |
| Drain-source voltage | | V _{DS} | 400 | V |
| Gate-source voltage | | V _{GS} | ± 20 | \ \ \ |
| Continuous drain current | V_{GS} at 10 V $T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 100 ^{\circ}\text{C}$ | | 1.7 | |
| Continuous drain current | $T_C = 100 ^{\circ}$ C | I _D | 1.1 | Α |
| Pulsed drain current ^a | | I _{DM} | 6.0 | |
| Linear derating factor | | | 0.20 | W/°C |
| Linear derating factor (PCB mount) e | | 0.020 | \\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\ | |
| Single pulse avalanche energy b | | E _{AS} | 86 | mJ |
| Repetitive avalanche current a | | I _{AR} | 1.7 | Α |
| Repetitive avalanche energy ^a | | E _{AR} | 2.5 | mJ |
| Maximum power dissipation | T _C = 25 °C | В | 25 | W |
| Maximum power dissipation (PCB mount) e | P _D | 2.5 | T VV | |
| Peak diode recovery dV/dt ^c | dV/dt | 4.0 | V/ns | |
| Operating junction and storage temperature range | | T _J , T _{stg} | -55 to +150 | °C |
| Soldering recommendations (peak temperature) d | For 10 s | | 260 | |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 52 \,^{\circ}\text{mH}$, $R_q = 25 \,^{\circ}\Omega$, $I_{AS} = 1.7 \,^{\circ}\text{A}$ (see fig. 12)
- c. $I_{SD} \le 1.7$ A, $dI/dt \le 40$ A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C
- d. 1.6 mm from case
- e. When mounted on 1" square PCB (FR-4 or G-10 material)

IRFR310, IRFU310, SiHFR310, SiHFU310

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| THERMAL RESISTANCE RATINGS | | | | | |
|--|-------------------|------|------|------|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | |
| Maximum junction-to-ambient (PCB mounted, steady-state) ^a | R _{thJA} | - | 50 | | |
| Maximum junction-to-ambient | R _{thJA} | - | 110 | °C/W | |
| Maximum junction-to-case | R_{thJC} | - | 5.0 | | |

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material)

| PARAMETER | SYMBOL | TES | T CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|-----------------------|--|---|-----------|-----------|----------------------|------------------|
| Static | | | | | | | |
| Drain-source breakdown voltage | V _{DS} | V _{GS} : | = 0 V, I _D = 250 μA | 400 | - | - | V |
| V _{DS} temperature coefficient | $\Delta V_{DS}/T_{J}$ | Reference | e to 25 °C, I _D = 1 mA | - | 0.47 | - | V/°C |
| Gate-source threshold voltage | V _{GS(th)} | V _{DS} = | = V _{GS} , I _D = 250 μA | 2.0 | - | 4.0 | V |
| Gate-source leakage | I _{GSS} | | V _{GS} = ± 20 V | - | - | ± 100 | nA |
| Zero gate voltage drain current | I _{DSS} | | = 400 V, V _{GS} = 0 V V, V _{GS} = 0 V, T _J = 125 °C | - | - | 25 250 | μA |
| Drain-source on-state resistance | R _{DS(on)} | V _{GS} = 10 V | | - | - | 3.6 | Ω |
| Forward transconductance | 9 _{fs} | | = 50 V, I _D = 1.0 A ^b | 0.97 | - | - | S |
| Dynamic | | | | | | | |
| Input capacitance | C _{iss} | | $V_{GS} = 0 V$, | - | 170 | - | |
| Output capacitance | C _{oss} | 1 | $V_{DS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ | - | 34 | - | рF |
| Reverse transfer capacitance | C _{rss} | f = 1.0 MHz, see fig. 5 ^c | | - | 6.3 | - | 1 |
| Total gate charge | Qg | | | - | - | 12 | |
| Gate-source charge | Q _{qs} | V _{GS} = 10 V | $V_{GS} = 10 \text{ V}$ $I_D = 2.0 \text{ A}, V_{DS} = 320 \text{ V},$ | | | 1.9 | nC |
| Gate-drain charge | Q _{qd} | see fig. 6 and 13 ^{b, c} | | - | - | 6.5 | |
| Turn-on delay time | t _{d(on)} | | l | - | 7.9 | - | |
| Rise time | t _r | | $200 \text{ V}, I_D = 2.0 \text{ A},$ | - | 9.9 | - | 1 |
| Turn-off delay time | t _{d(off)} | $R_{g} = 24 \Omega, R_{D} = 95 \Omega,$ see fig. $10^{b, c}$ | | - | 21 | - | ns |
| Fall time | t _f | 1 | See lig. 10 % | | 11 | - | |
| Gate input resistance | Rq | f = 1 MHz, open drain | | 1.7 | - | 11.2 | Ω |
| Internal drain inductance | L _D | Between 6 mm (0.25 | ") from | - | 4.5 | - | |
| Internal source inductance | L _S | package and die cont | ا ا ا ا | - | 7.5 | - | - nH |
| Drain-Source Body Diode Characteristic | cs | | | | | | • |
| Continuous source-drain diode current | I _S | MOSFET sym showing the | bol | - | - | 1.7 | Α |
| Pulsed diode forward current ^a | I _{SM} | integral reverse p - n junction diode | | - | - | 6.0 | |
| Body diode voltage | V _{SD} | T _J = 25 °C | , I _S = 1.7 A, V _{GS} = 0 V ^b | - | - | 1.6 | V |
| Body diode reverse recovery time | t _{rr} | T - 25 °C 1 | - 2.0 A dl/dt - 100 A/::a b | - | 240 | 540 | ns |
| Body diode reverse recovery charge | Q _{rr} | 1J=25 C, IF | = 2.0 A, dl/dt = 100 A/µs b | - | 0.85 | 1.6 | μC |
| Forward turn-on time | t _{on} | Intrinsic tu | ırn-on time is negligible (turn | on is dor | ninated b | y L _S and | L _D) |

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11) b. Pulse width \leq 300 µs; duty cycle \leq 2 %

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

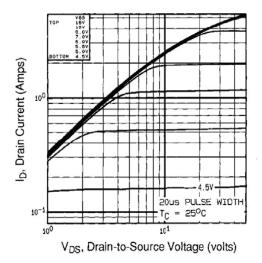


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

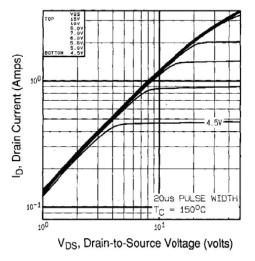


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

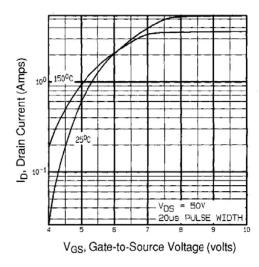


Fig. 3 - Typical Transfer Characteristics

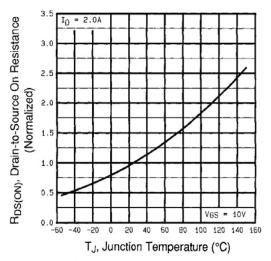


Fig. 4 - Normalized On-Resistance vs. Temperature



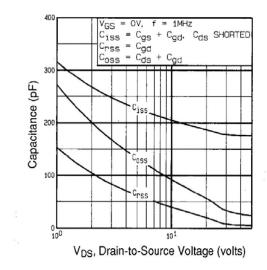


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

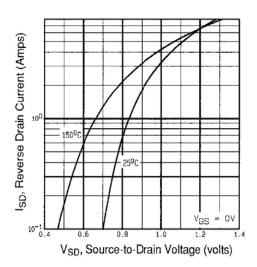


Fig. 7 - Typical Source-Drain Diode Forward Voltage

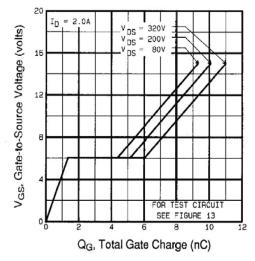


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

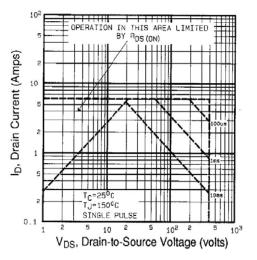


Fig. 8 - Maximum Safe Operating Area



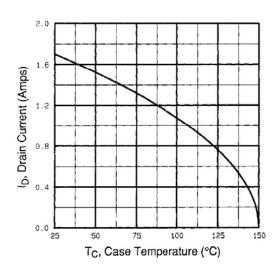


Fig. 9 - Maximum Drain Current vs. Case Temperature

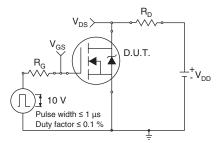


Fig. 10a - Switching Time Test Circuit

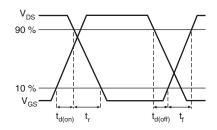


Fig. 10b - Switching Time Waveforms

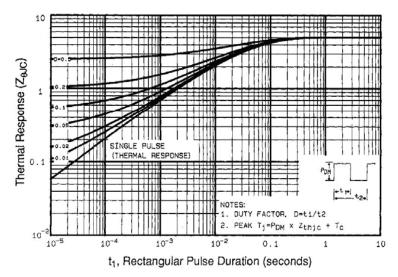


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

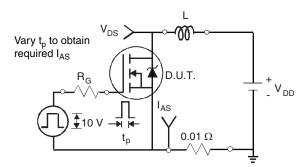


Fig. 12a - Unclamped Inductive Test Circuit

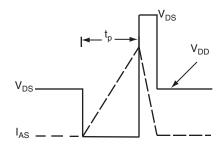


Fig. 12b - Unclamped Inductive Waveforms

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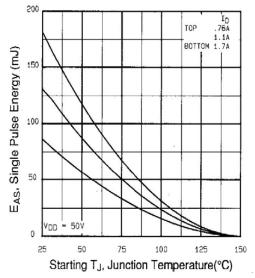


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

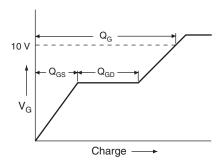


Fig. 13a - Basic Gate Charge Waveform

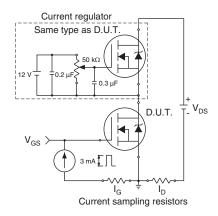
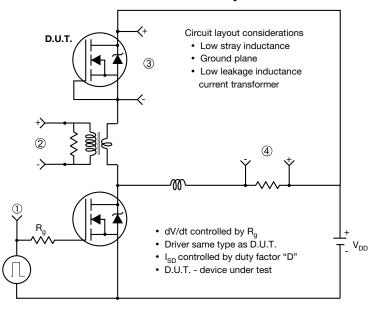


Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



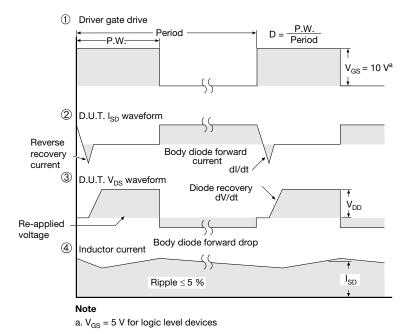


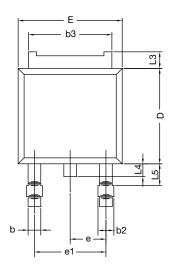
Fig. 14 - For N-Channel

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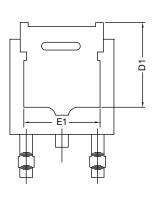


TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







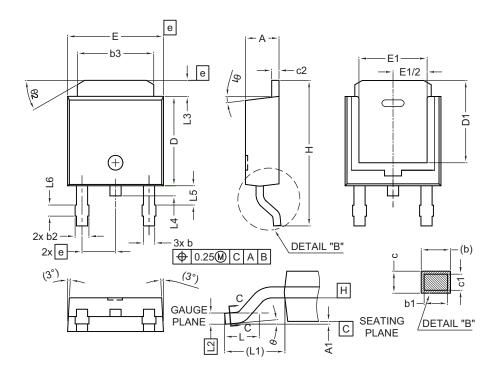
| | MILLIMETERS | | |
|------|-------------|-------|--|
| DIM. | MIN. | MAX. | |
| A | 2.18 | 2.38 | |
| A1 | - | 0.127 | |
| b | 0.64 | 0.88 | |
| b2 | 0.76 | 1.14 | |
| b3 | 4.95 | 5.46 | |
| С | 0.46 | 0.61 | |
| C2 | 0.46 | 0.89 | |
| D | 5.97 | 6.22 | |
| D1 | 4.10 | - | |
| E | 6.35 | 6.73 | |
| E1 | 4.32 | - | |
| Н | 9.40 | 10.41 | |
| е | 2.28 | BSC | |
| e1 | 4.56 | BSC | |
| L | 1.40 | 1.78 | |
| L3 | 0.89 | 1.27 | |
| L4 | - | 1.02 | |
| L5 | 1.01 | 1.52 | |

Note

• Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



| | MILLIMETERS | | |
|------|-------------|-------|--|
| DIM. | MIN. | MAX. | |
| Α | 2.18 | 2.39 | |
| A1 | - | 0.13 | |
| b | 0.65 | 0.89 | |
| b1 | 0.64 | 0.79 | |
| b2 | 0.76 | 1.13 | |
| b3 | 4.95 | 5.46 | |
| С | 0.46 | 0.61 | |
| c1 | 0.41 | 0.56 | |
| c2 | 0.46 | 0.60 | |
| D | 5.97 | 6.22 | |
| D1 | 5.21 | = | |
| E | 6.35 | 6.73 | |
| E1 | 4.32 | - | |
| е | 2.29 BSC | | |
| Н | 9.94 | 10.34 | |

| | MILLIMETERS | | |
|------|-------------|--------|--|
| DIM. | MIN. | MAX. | |
| L | 1.50 | 1.78 | |
| L1 | 2.74 | ł ref. | |
| L2 | 0.51 | BSC | |
| L3 | 0.89 | 1.27 | |
| L4 | - | 1.02 | |
| L5 | 1.14 | 1.49 | |
| L6 | 0.65 | 0.85 | |
| θ | 0° | 10° | |
| θ1 | 0° | 15° | |
| θ2 | 25° | 35° | |

Notes

- Dimensioning and tolerance confirm to ASME Y14.5M-1994
- All dimensions are in millimeters. Angles are in degrees
- Heat sink side flash is max. 0.8 mm
- Radius on terminal is optional

ECN: E19-0649-Rev. Q, 16-Dec-2019

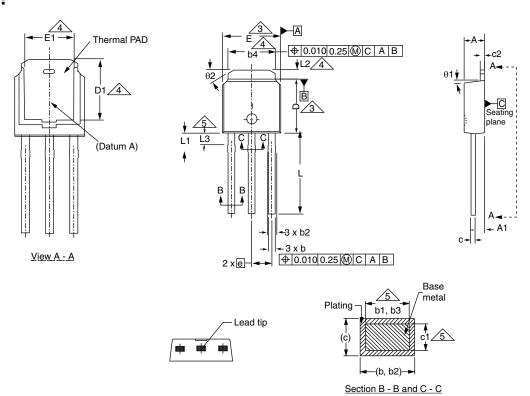
DWG: 5347

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Case Outline for TO-251AA (High Voltage)

OPTION 1:



| | MILLIMETERS | | INC | HES |
|------|-------------|------|-------|-------|
| DIM. | MIN. | MAX. | MIN. | MAX. |
| Α | 2.18 | 2.39 | 0.086 | 0.094 |
| A1 | 0.89 | 1.14 | 0.035 | 0.045 |
| b | 0.64 | 0.89 | 0.025 | 0.035 |
| b1 | 0.65 | 0.79 | 0.026 | 0.031 |
| b2 | 0.76 | 1.14 | 0.030 | 0.045 |
| b3 | 0.76 | 1.04 | 0.030 | 0.041 |
| b4 | 4.95 | 5.46 | 0.195 | 0.215 |
| С | 0.46 | 0.61 | 0.018 | 0.024 |
| c1 | 0.41 | 0.56 | 0.016 | 0.022 |
| c2 | 0.46 | 0.86 | 0.018 | 0.034 |
| D | 5.97 | 6.22 | 0.235 | 0.245 |

| | MILLIMETERS | | INC | HES |
|------|-------------|----------|-------|-------|
| DIM. | MIN. | MAX. | MIN. | MAX. |
| D1 | 5.21 | - | 0.205 | - |
| Е | 6.35 | 6.73 | 0.250 | 0.265 |
| E1 | 4.32 | = | 0.170 | = |
| е | 2.29 | 2.29 BSC | | BSC |
| L | 8.89 | 9.65 | 0.350 | 0.380 |
| L1 | 1.91 | 2.29 | 0.075 | 0.090 |
| L2 | 0.89 | 1.27 | 0.035 | 0.050 |
| L3 | 1.14 | 1.52 | 0.045 | 0.060 |
| θ1 | 0' | 15' | 0' | 15' |
| θ2 | 25' | 35' | 25' | 35' |
| | • | | • | |

ECN: E21-0682-Rev. C, 27-Dec-2021

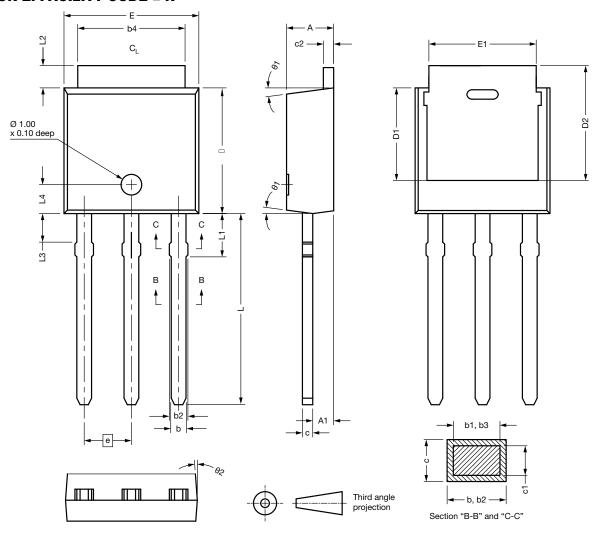
DWG: 5968

Notes

- Dimensioning and tolerancing per ASME Y14.5M-1994
- Dimension are shown in inches and millimeters
- Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- Thermal pad contour optional with dimensions b4, L2, E1 and D1
- Lead dimension uncontrolled in L3
- Dimension b1, b3 and c1 apply to base metal only
- Outline conforms to JEDEC® outline TO-251AA



OPTION 2: FACILITY CODE = N



| DIM. | MIN. | NOM. | MAX. |
|------|-------|-------|-------|
| Α | 2.180 | 2.285 | 2.390 |
| A1 | 0.890 | 1.015 | 1.140 |
| b | 0.640 | 0.765 | 0.890 |
| b1 | 0.640 | 0.715 | 0.790 |
| b2 | 0.760 | 0.950 | 1.140 |
| b3 | 0.760 | 0.900 | 1.040 |
| b4 | 4.950 | 5.205 | 5.460 |
| С | 0.460 | 1 | 0.610 |
| c1 | 0.410 | - | 0.560 |
| c2 | 0.460 | - | 0.610 |
| D | 5.970 | 6.095 | 6.220 |
| D1 | 4.300 | - 1 | ı |

| DIM. | MIN. | NOM. | MAX. |
|------|-------|-------|-------|
| D2 | 5.380 | - | - |
| E | 6.350 | 6.540 | 6.730 |
| E1 | 4.32 | - | - |
| е | 2.29 | BSC | |
| L | 8.890 | 9.270 | 9.650 |
| L1 | 1.910 | 2.100 | 2.290 |
| L2 | 0.890 | 1.080 | 1.270 |
| L3 | 1.140 | 1.330 | 1.520 |
| L4 | 1.300 | 1.400 | 1.500 |
| θ1 | 0° | 7.5° | 15° |
| θ2 | 4° | - | - |
| | | | |

ECN: E21-0682-Rev. C, 27-Dec-2021

DWG: 5968

Notes

- Dimensioning and tolerancing per ASME Y14.5M-1994
- All dimension are in millimeters, angles are in degrees
- Heat sink side flash is max. 0.8 mm



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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